Maximum Ratings at Tj = 25 °C unless otherwise specified

Parameter	Symbol	Value	Unit
Drain source voltage	V_{DS}	60	V
Drain source voltage for short circuit protection	$V_{DS(SC)}$	32	
Continuous input current [1] $-0.2V \le V_{IN} \le 10V$ $V_{IN} < -0.2V$ or $V_{IN} > 10V$	I_{IN}	 no limit $\lvert I_{IN} \rvert \le 2$	mA
Operating temperature	T_j	- 40 ... +150	°C
Storage temperature	T_{stg}	- 55 ... +150	
Power dissipation T_C = 25 °C	P_{tot}	149	W
Unclamped single pulse inductive energy $I_{D(ISO)}$ = 12 A	E_{AS}	4000	mJ
Electrostatic discharge voltage (Human Body Model) according to MIL STD 883D, method 3015.7 and EOS/ESD assn. standard S5.1 - 1993	V_{ESD}	3000	V
Load dump protection $V_{LoadDump}$[2] = V_A + V_S V_{IN}=low or high; V_A=13.5 V t_d = 400 ms, R_I = 2 Ω, I_D=0,5*12A t_d = 400 ms, R_I = 2 Ω, I_D= 12A	V_{LD}	 100 84	

Thermal resistance

junction - case:	R_{thJC}	0.84	K/W
junction - ambient:	R_{thJA}	75	
SMD version, device on PCB: [3]	R_{thJA}	45	

[1] In case of thermal shutdown a minimum sensor holding current of 500 µA has to be guaranteed (see also page 3).

[2] $V_{Loaddump}$ is setup without the DUT connected to the generator per ISO 7637-1 and DIN 40839

[3] Device on 50mm*50mm*1.5mm epoxy PCB FR4 with 6cm^2 (one layer, 70µm thick) copper area for Drain connection. PCB mounted vertical without blown air.

Electrical Characteristics

Parameter at T_j=25°C, unless otherwise specified	Symbol	Values			Unit
		min.	typ.	max.	
Characteristics					
Drain source clamp voltage T_j = - 40 ...+ 150°C, I_D = 10 mA	$V_{DS(AZ)}$	60	-	73	V
Off state drain current V_{DS} = 32 V, T_j = -40...+150 °C, V_{IN} = 0 V	I_{DSS}	-	-	20	µA
Input threshold voltage I_D = 2,7 mA	$V_{IN(th)}$	1.3	1.7	2.2	V
Input current - normal operation, I_D<$I_{D(lim)}$: V_{IN} = 10 V	$I_{IN(1)}$	-	35	100	µA
Input current - current limitation mode, I_D=$I_{D(lim)}$: V_{IN} = 10 V	$I_{IN(2)}$	-	270	500	
Input current - after thermal shutdown, I_D=0 A: V_{IN} = 10 V	$I_{IN(3)}$	1000	2500	4000	
Input holding current after thermal shutdown [1)] T_j = 25 °C T_j = 150 °C	$I_{IN(H)}$	 500 300	 - -	 - -	
On-state resistance V_{IN} = 5 V, I_D = 12 A, T_j = 25 °C V_{IN} = 5 V, I_D = 12 A, T_j = 150 °C	$R_{DS(on)}$	 - -	 31 52	 34 68	mΩ
On-state resistance V_{IN} = 10 V, I_D = 12 A, T_j = 25 °C V_{IN} = 10 V, I_D = 12 A, T_j = 150 °C	$R_{DS(on)}$	 - -	 25 45	 28 56	
Nominal load current (ISO 10483) V_{IN} = 10 V, V_{DS} = 0.5 V, T_C = 85 °C	$I_{D(ISO)}$	12	-	-	A

[1] If the input current is limited by external components, low drain currents can flow and heat the device. Auto restart behaviour can occur.

Electrical Characteristics

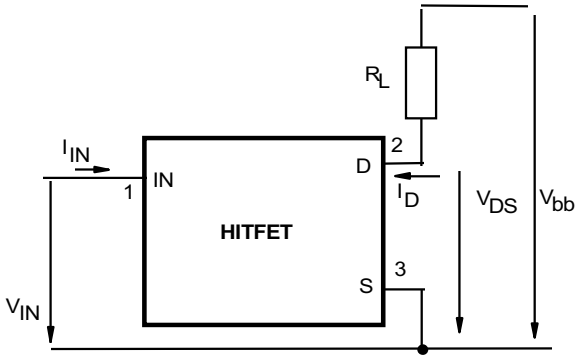
Parameter at T_j=25°C, unless otherwise specified	Symbol	Values			Unit
		min.	typ.	max.	
Characteristics					
Initial peak short circuit current limit V_{IN} = 10 V, V_{DS} = 12 V	$I_{D(SCp)}$	-	100	-	A
Current limit [1] V_{IN} = 10 V, V_{DS} = 12 V, t_m = 350 µs, T_j = -40...+150 °C	$I_{D(lim)}$	25	35	50	
Dynamic Characteristics					
Turn-on time V_{IN} to 90% I_D: R_L = 2,2 Ω, V_{IN} = 0 to 10 V, V_{bb} = 12 V	t_{on}	-	40	100	µs
Turn-off time V_{IN} to 10% I_D: R_L = 2,2 Ω, V_{IN} = 10 to 0 V, V_{bb} = 12 V	t_{off}	-	70	170	
Slew rate on 70 to 50% V_{bb}: R_L = 2,2 Ω, V_{IN} = 0 to 10 V, V_{bb} = 12 V	$-dV_{DS}/dt_{on}$	-	1	3	V/µs
Slew rate off 50 to 70% V_{bb}: R_L = 2,2 Ω, V_{IN} = 10 to 0 V, V_{bb} = 12 V	dV_{DS}/dt_{off}	-	1	3	
Protection Functions [2]					
Thermal overload trip temperature	T_{jt}	150	165	-	°C
Unclamped single pulse inductive energy I_D = 12 A, T_j = 25 °C, V_{bb} = 32 V I_D = 12 A, T_j = 150 °C, V_{bb} = 32 V	E_{AS}	 4000 900	 - -	 - -	mJ
Inverse Diode					
Inverse diode forward voltage I_F = 5*12A, t_m = 300 µS, V_{IN} = 0 V	V_{SD}	-	1.13	-	V

[1] Device switched on into existing short circuit (see diagram Determination of $I_{D(lim)}$). If the device is in on condition and a short circuit occurs, these values might be exceeded for max. 50 µs.

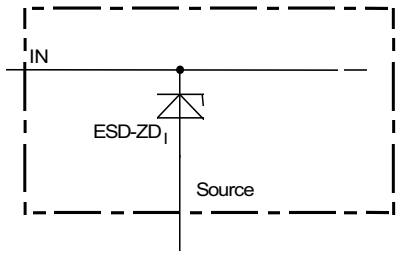
[2] Integrated protection functions are designed to prevent IC destruction under fault conditions described in the data sheet. Fault conditions are considered as "outside" normal operating range. Protection functions are not designed for continuous repetitive operation.

Block Diagramm

Terms

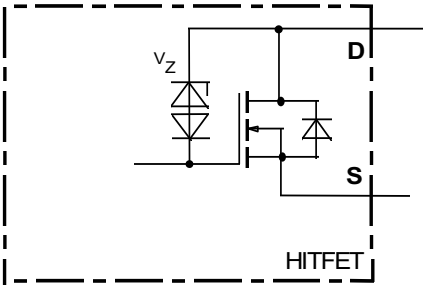


Input circuit (ESD protection)

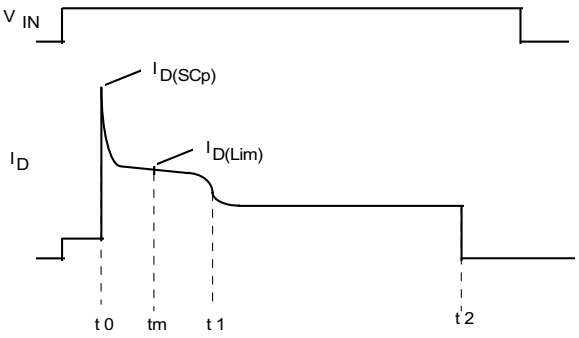


ESD zener diodes are not designed for DC current > 2 mA @ V_{IN}>10V.

Inductive and overvoltage output clamp



Short circuit behaviour



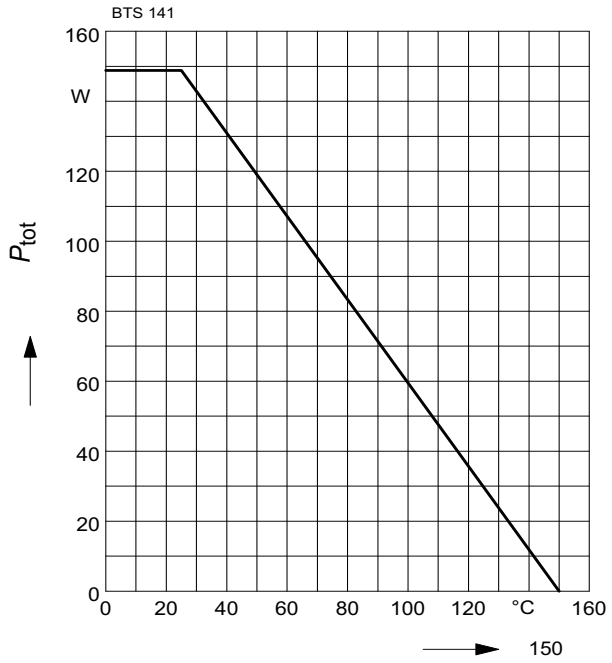
t_0: Turn on into a short circuit

t_m: Measurementpoint for $I_{D(lim)}$

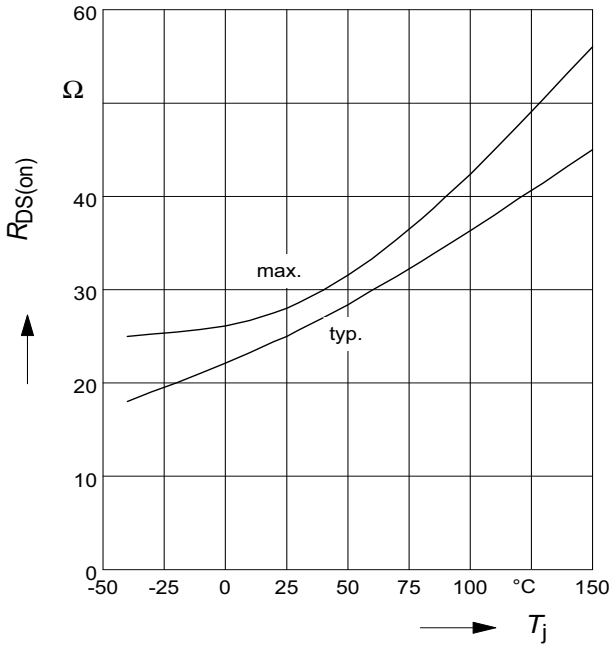
t_1: Activation of the fast temperature sensor and regulation of the drain current to a level where the junction temperature remains constant.

t_2: Thermal shutdown caused by the second temperature sensor, achieved by an integrating measurement.

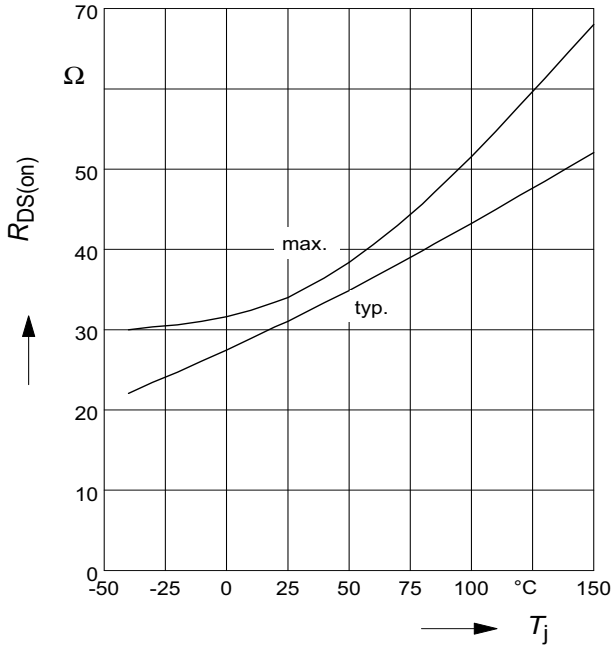
Maximum allowable power dissipation
$P_{tot} = f(T_C)$



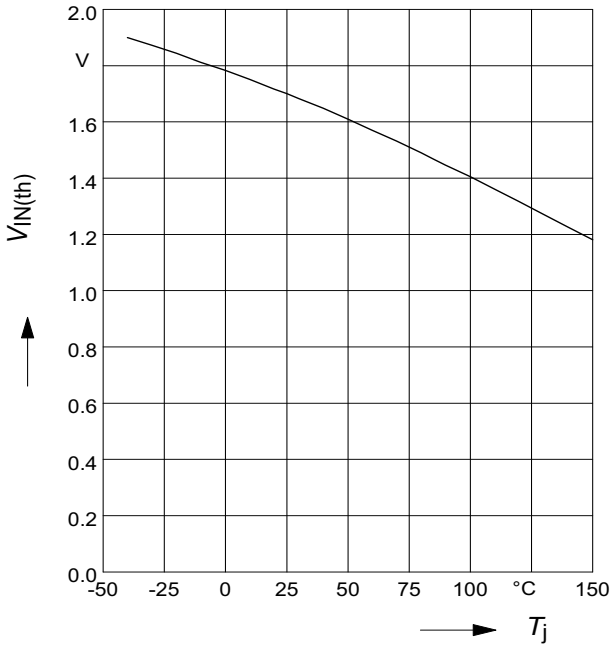
On-state resistance
$R_{ON} = f(T_j)$; I_D=12A; V_{IN}=10V



On-state resistance
$R_{ON} = f(T_j)$; I_D= 12A; V_{IN}=5V

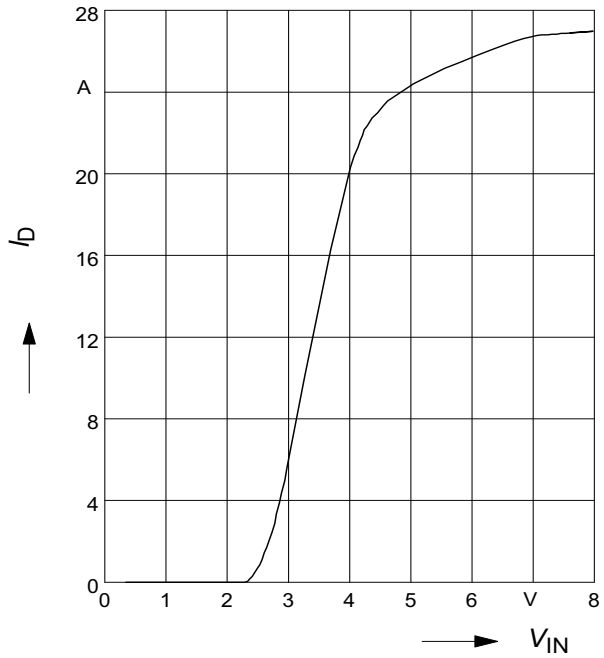


Typ. input threshold voltage
$V_{IN(th)} = f(T_j)$; I_D=2,7mA; V_{DS}=12V



Typ. transfer characteristics

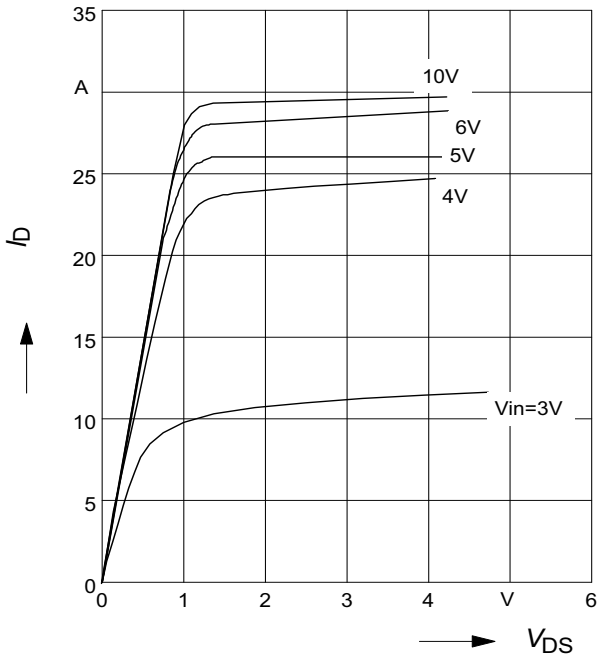
I_D = f(V_{IN}); V_{DS}=12V; T_j=25°C



Typ. output characteristic

I_D = f(V_{DS}); T_j=25°C

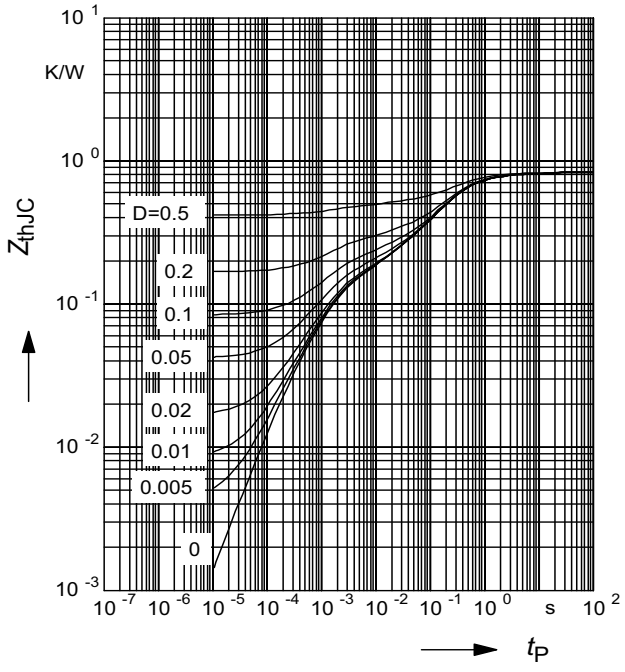
Parameter: V_{IN}



Transient thermal impedance

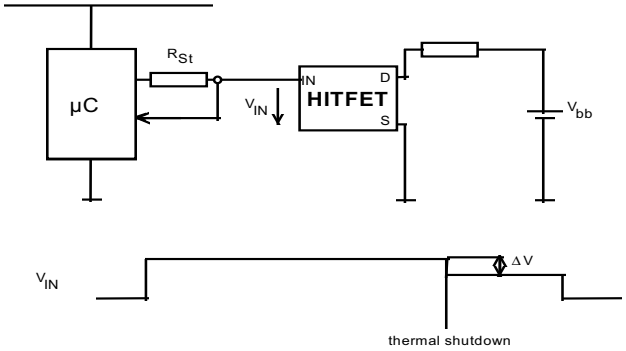
$Z_{thJC} = f(t_p)$

parameter : $D = t_p/T$



Application examples:

Status signal of thermal shutdown by monitoring input current



$\Delta V = R_{ST} * I_{IN(3)}$

1 Package Outlines

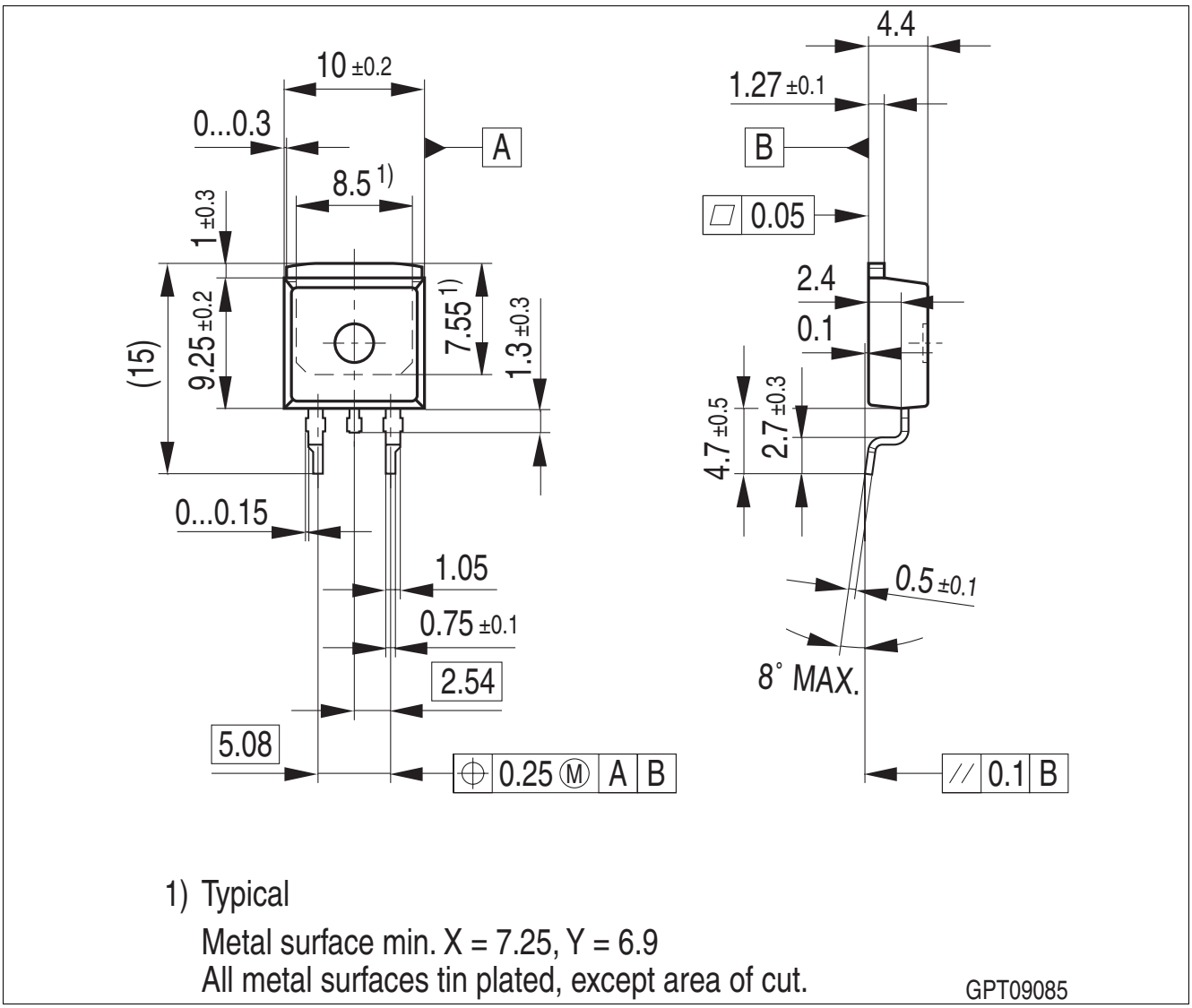


Figure 1 PG-TO263-3-2

To meet the world-wide customer requirements for environmentally friendly products and to be compliant with government regulations the device is available as a green product. Green products are RoHS-Compliant (i.e Pb-free finish on leads and suitable for Pb-free soldering according to IPC/JEDEC J-STD-020).

You can find all of our packages, sorts of packing and others in our Infineon Internet Page “Products”: **http://www.infineon.com/products**.

Dimensions in mm

2 Revision History

Version	Date	Changes
Rev. 1.0	2009-07-20	released initial Datasheet

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